

Film Carrier Sockets and Pins

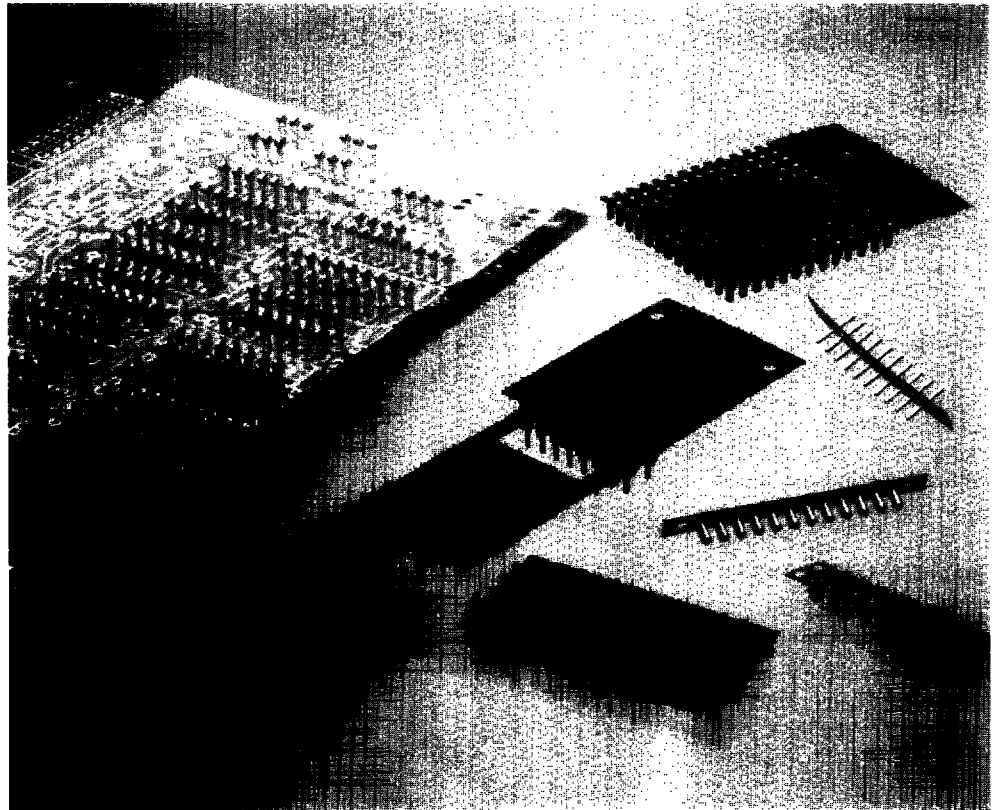
Product Facts

- Low profile — .015–.031 [0.38–0.78] above PC board
- Film carrier withstands temperatures to +400°C
- Manual assembly
- Closed Bottom — inhibits flux and solder wicking
- Ease of removing film carrier after soldering
- Visual inspection on both sides of pc board
- Excellent air flow around IC's
- Footprints to customer requirements
- Customer multiple footprints on single film carrier

Recognized under the Component Program of Underwriters Laboratories Inc., File No. E28476



Certified by Canadian Standards Association, File No. LR7189A-97



AMP Film Carrier Sockets and Pins, ideal for extremely low-profile, high-density applications, are affixed to a disposable film carrier which is removed after soldering. The sockets are available in standard DIP, SIP, ZIP and PGA configurations, as well as in custom layouts and multiple patterns on a single carrier.

The sockets are compatible with vapor phase, infrared, hand and wave soldering. The socket/carrier assembly is manually placed on the board (Select surface mount assemblies can be robotically placed). Following soldering, the carrier is peeled away, leaving free-standing socket terminals that allow visual inspection, easy flux removal and excellent heat dissipation. The flexible carrier eliminates concern about contact damage

during carrier insertion or extraction.

The sockets offer low height above the pc board (.015–.031 [0.38–0.78]), permit excellent air flow around ICs, and allow very dense packaging, with the smallest socket being .058 [1.47] in diameter.

Male pins that mate with the sockets are also available for modular board-to-board interconnection.

Performance Characteristics

Termination Resistance, Dry Circuit: 20 milliohms, max. initial

Vibration, Sinusoidal High Freq.: 15 G's between 10–2000 Hz

Physical Shock: 100 G's

Contact Retention: 7.5 lbs. [33.36 N]

Durability: 25 Cycles

Thermal Shock: –40°C to +125°C

Technical Documents

Product Specification: 108-1334

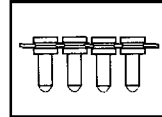
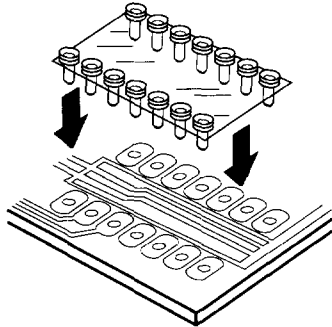
Qualification Test Report: 501-177

Insertion and Withdrawal Force (Average):

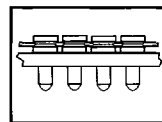
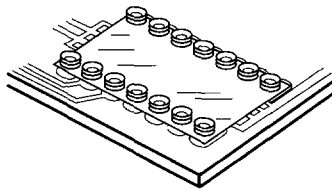
Terminal Types	Force With .018 [0.46] Diameter Test Pin			
	Gold Plated Contact		Tin/Lead Plated Contact	
	Insertion	Withdrawal	Insertion	Withdrawal
A, L, M	2.65 oz. [75g]	1.41 oz. [40g]	—	—
B, C, D, F & K	2.65 oz. [75g]	1.59 oz. [45g]	8.82 oz. [250g]	2.65 oz. [75g]
E	3.53 oz. [100g]	2.12 oz. [60g]	12.34 oz. [350g]	5.29 oz. [150g]

Film Carrier Sockets and Pins (Continued)**How to Use
Film Carrier
Sockets and Pins**

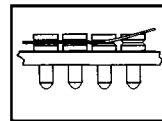
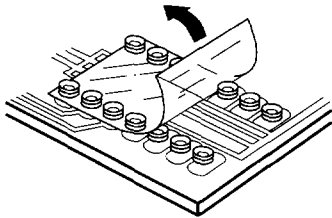
1. Place Film Carrier Socket in pc board.



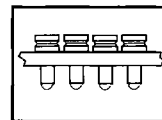
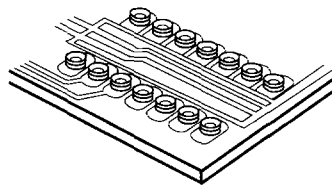
2. Send pc board and Film Carrier Socket through soldering operation.



3. Strip away film carrier.



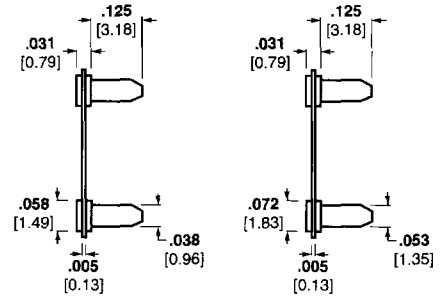
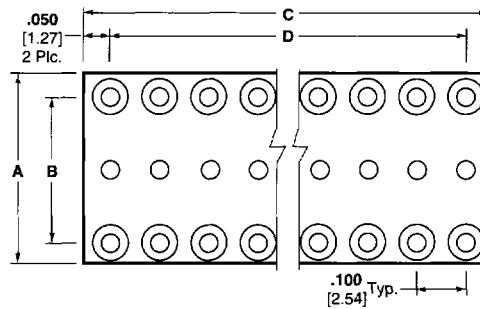
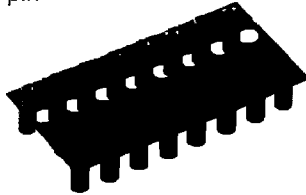
4. Free standing socket terminal for improved inspection, cleaning and dissipation of heat.



Film Carrier Sockets (Continued)

DIP Socket Assemblies

Sockets will accept a .016-.021 [0.41-0.53] diameter or .018 [0.25 x 0.46] rectangular pin



Type A

Type B

Materials

Film — Polyimide

Sleeves — Brass, 1/2 Hard
Composition 22, Copper Alloy 360, QQ-B-626

Contacts — Beryllium Copper, 1/4 Hard Copper Alloy 172 ASTM-8-194, QQ-C-533, Heat Treated

Finish

Contacts — .000030 [0.00076] Gold over .000050 [0.00127] Nickel or .000150 [0.0038] to .000275 [0.00699] Tin/Lead Type 1 over .000050 [0.00127] to .000100 [0.00254] Nickel

Sleeves — .000200 [0.00508] to .000300 [0.00762] Tin/Lead Type 1 over 0.000050 [0.00127] to .000100 [0.00254] Nickel

Plating Specifications —
Nickel per QQ-N-290
Gold per MIL-G-45204
Tin/Lead per MIL-P-81728

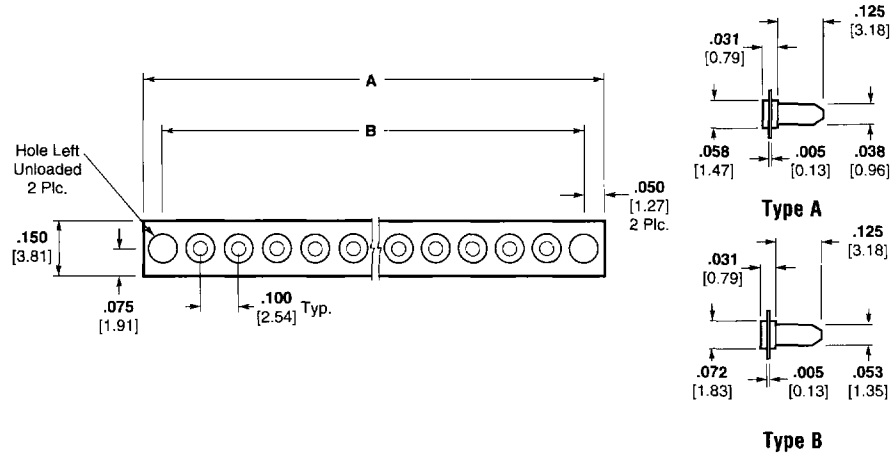
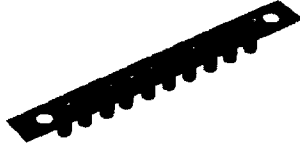
No. of Pos.	Dimensions				Terminal Types ¹	Minimum Acceptable Pin Length	Part Numbers	
	A	B	C	D			Contact Tin / Sleeve Tin	Contact Gold / Sleeve Tin
8	.400 10.16	.300 7.62	.400 10.16	.300 7.62	A	.090 2.29	—	382522-8
					B	.075 1.91	382447-8	382459-8
14	.400 10.16	.300 7.62	.700 17.78	.600 15.24	A	.090 2.29	—	1-382522-4
					B	.075 1.91	1-382447-4	1-382459-4
16	.400 10.16	.300 7.62	.800 20.32	.700 17.78	A	.090 2.29	—	1-382522-6
					B	.075 1.91	1-382447-6	1-382459-6
18	.400 10.16	.300 7.62	.900 22.86	.800 20.32	A	.090 2.29	—	1-382522-8
					B	.075 1.91	1-382447-8	1-382459-8
20	.400 10.16	.300 7.62	1.000 25.40	.900 22.86	A	.090 2.29	—	2-382522-0
					B	.075 1.91	2-382447-0	2-382459-0
24	.400 10.16	.300 7.62	1.200 30.48	1.100 27.94	A	.090 2.29	—	2-382522-4
					B	.075 1.91	2-382447-4	2-382459-4
28	.700 17.78	.600 15.24	1.400 35.56	1.300 33.02	A	.090 2.29	—	2-382522-8
					B	.075 1.91	2-382447-8	2-382459-8
32	.700 17.78	.600 15.24	1.600 40.64	1.500 38.10	A	.090 2.29	—	3-382522-2
					B	.075 1.91	3-382447-2	3-382459-2
40	.700 17.78	.600 15.24	2.000 50.80	1.900 48.26	A	.090 2.29	—	4-382522-0
					B	.075 1.91	4-382447-0	4-382459-0
64	1.000 25.40	.900 22.86	3.200 81.28	3.100 78.74	A	.090 2.29	—	6-382522-4
					B	.075 1.91	6-382447-4	6-382459-4

¹Standard terminal types are listed on pages 160 and 161. Any terminal type can be made available in this configuration; contact AMP Incorporated.
Note: See page 159 for samples of terminal types for customer evaluation.

Film Carrier Sockets (Continued)

SIP Socket Assemblies

Sockets will accept a .016-.021 [0.41-0.53] diameter or .010 × .018 [0.25 × 0.46] rectangular pin



Materials

Film — Polyimide

Sleeves — Brass, 1/2 Hard
Composition 22, Copper Alloy 360, QQ-B-626

Contacts — Beryllium Copper, 1/4 Hard Copper Alloy 172 ASTM-8-194, QQ-C-533, Heat Treated

Finish

Contacts — .000030 [0.00076] Gold over .000050 [0.00127] Nickel or .000150 [0.0038] to .000275 [0.00699] Tin/Lead Type 1 over .000050 [0.00127] to .000100 [0.00254] Nickel

Sleeves — .000200 [0.00508] to .000300 [0.00762] Tin/Lead Type 1 over .000050 [0.00127] to .000100 [0.00254] Nickel

Plating Specifications —
Nickel per QQ-N-290
Gold per MIL-G-45204
Tin/Lead per MIL-P-81728

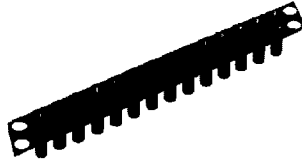
No. of Pos.	Dimensions		Terminal Types ¹	Minimum Acceptable Pin Length	Part Numbers	
	A	B			Contact / Sleeve Tin	Contact / Sleeve Gold Tin
8	1.000 25.40	.900 22.86	A	.090 2.29	—	382521-8
			B	.075 1.91	382445-8	382495-8
10	1.200 30.48	1.100 27.94	A	.090 2.29	—	1-382521-0
			B	.075 1.91	1-382445-0	1-382495-0
12	1.400 35.56	1.300 33.02	A	.090 2.29	—	1-382521-2
			B	.075 1.91	1-382445-2	1-382495-2
14	1.600 40.64	1.500 38.10	A	.090 2.29	—	1-382521-4
			B	.075 1.91	1-382445-4	1-382495-4
16	1.800 45.72	1.700 43.18	A	.090 2.29	—	1-382521-6
			B	.075 1.91	1-382445-6	1-382495-6
20	2.200 55.88	2.100 53.34	A	.090 2.29	—	2-382521-0
			B	.075 1.91	2-382445-0	2-382495-0
24	2.600 66.04	2.500 63.50	A	.090 2.29	—	2-382521-4
			B	.075 1.91	2-382445-4	2-382495-4
100	10.200 259.08	10.100 256.54	A	.090 2.29	—	382521-1
			B	.075 1.91	382445-1	382495-1

¹Standard terminal types are listed on pages 160 and 161.
Any terminal type can be made available in this configuration; contact AMP Incorporated.
Note: See page 159 for samples of terminal types for customer evaluation.

Film Carrier Sockets (Continued)

ZIP Socket Assemblies

Sockets will accept a .016-.021 [0.41-0.53] diameter or .010 × .018 [0.25 × 0.46] rectangular pin



Materials

Film — Polyimide

Sleeves — Brass, 1/2 Hard
Composition 22, Copper Alloy 360, QQ-B-626

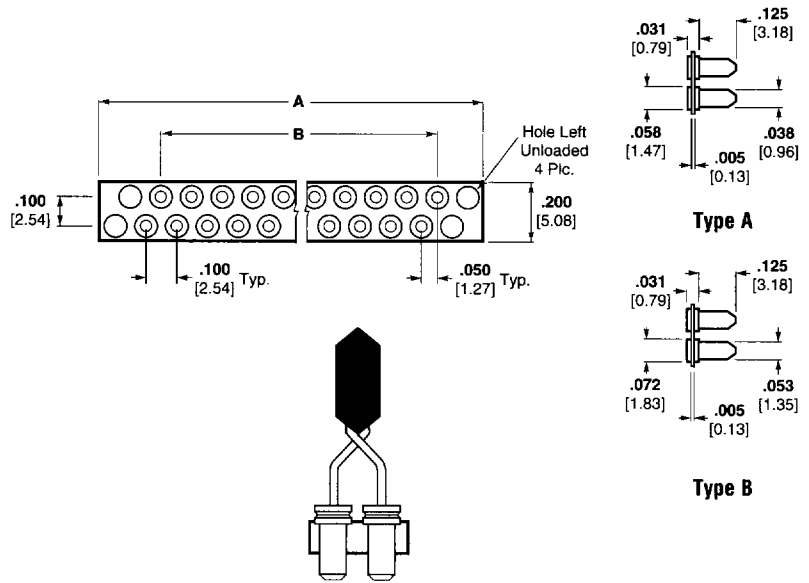
Contacts — Beryllium Copper, 1/4 Hard Copper Alloy 172 ASTM-8-194, QQ-C-533, Heat Treated

Finish

Contacts — .000030 [0.00076] Gold over .000050 [0.00127] Nickel or .000150 [0.0038] to .000275 [0.00699] Tin/Lead Type 1 over .000050 [0.00127] to .000100 [0.00254] Nickel

Sleeves — .000200 [0.00508] to .000300 [0.00762] Tin/Lead Type 1 over 0.000050 [0.00127] to .000100 [0.00254] Nickel

Plating Specifications —
Nickel per QQ-N-290
Gold per MIL-G-45204
Tin/Lead per MIL-P-81728



Typical Assembly View

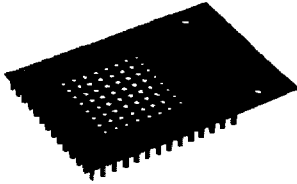
No. of Pos.	Dimensions		Terminal Types ¹	Minimum Acceptable Pin Length	Part Numbers	
	A	B			Contact / Sleeve Tin	Contact / Sleeve Gold / Tin
20	1.250 31.75	.900 22.86	A	.090 2.29	—	2-382520-0
			B	.075 1.91	2-382448-0	2-382458-0
24	1.450 36.83	1.100 27.94	A	.090 2.29	—	1-382520-4
			B	.075 1.91	2-382448-4	2-382458-4
28	1.650 41.91	1.300 33.02	A	.090 2.29	—	2-382520-8
			B	.075 1.91	2-382448-8	2-382458-8
40	2.250 57.15	1.900 48.26	A	.090 2.29	—	4-382520-0
			B	.075 1.91	4-382448-0	4-382458-0

¹Standard terminal types are listed on pages 160 and 161.
Any terminal type can be made available in this configuration; contact AMP Incorporated.
Note: See page 159 for samples of terminal types for customer evaluation.

Film Carrier Sockets (Continued)

PGA Socket Assemblies

Sockets will accept a .016-.021 [0.41-0.53] diameter or .010 × .018 [0.25 × 0.46] rectangular pin



Materials

Film — Polyimide

Sleeves — Brass, 1/2 Hard
Composition 22, Copper Alloy 360,
QQ-B-626

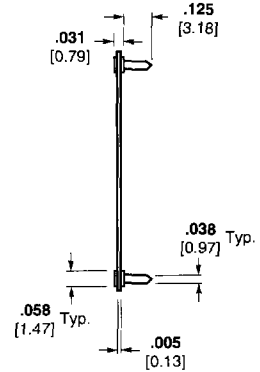
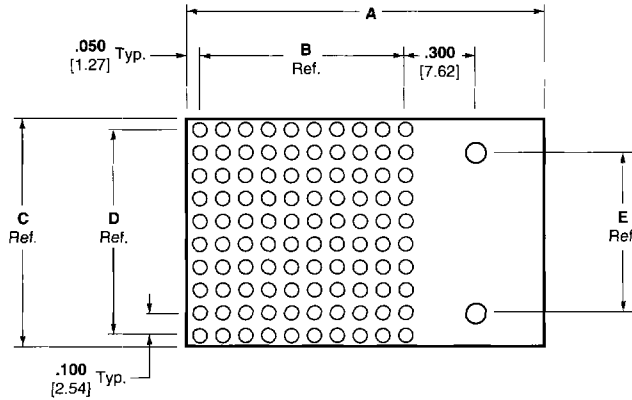
Contacts — Beryllium Copper,
1/4 Hard Copper Alloy 172 ASTM-8-
194, QQ-C-533, Heat Treated

Finish

Contacts — .000030 [0.00076]
Gold over .000050 [0.00127]
Nickel

Sleeves — .000200 [0.00508]
Tin/Lead over 0.000050 [0.00127]
Nickel

Plating Specifications —
Nickel per QQ-N-290
Gold per MIL-G-45204
Tin/Lead per MIL-P-81728



Grid Size	No. of Pos.	Dimensions					Terminal Type ¹	Minimum Acceptable Pin Length	Base Part Number ²
		A	B	C	D	E			
10 × 10	68, 84 and 100	1.550	.900	1.000	.900	.700	A	.090 2.29	382450
		39.37	22.86	25.40	22.86	17.78			
11 × 11	68, 84 and 121	1.650	1.000	1.100	1.000	.800	A	.090 2.29	382451
		41.91	25.40	27.94	25.40	20.32			
13 × 13	114, 121 and 169	1.850	1.200	1.300	1.200	1.000	A	.090 2.29	382453
		46.99	30.48	33.02	30.48	25.40			
14 × 14	132 and 196	1.950	1.300	1.400	1.300	1.100	A	.090 2.29	382454
		49.53	33.02	35.56	33.02	27.94			
15 × 15	145, 149 and 181	2.050	1.400	1.500	1.400	1.200	A	.090 2.29	382455
		52.07	35.56	38.10	35.56	30.48			
17 × 17	168 and 169	2.250	1.600	1.700	1.600	1.400	A	.090 2.29	382457
		57.15	40.64	43.18	40.64	35.56	L ³		
19 × 19	238 and 280	2.450	1.800	1.900	1.800	1.600	L ³	.090 2.29	382685
		62.23	45.72	48.26	45.72	40.64			
21 × 21	273	2.650	2.000	2.100	2.000	1.800	L ³	.090 2.29	382686
		67.31	50.80	53.34	50.80	45.72			

¹Standard terminal types are listed on pages 160 and 161.

²See pages 154 and 155 for patterns and part number suffixes.

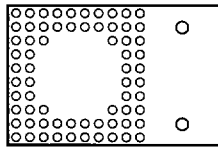
³Low force, staggered contacts. See page 162 for Type L cross-section.

Any terminal type can be made available in this configuration; contact AMP Incorporated.

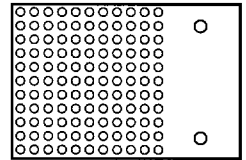
Note: See page 159 for samples of terminal types for customer evaluation.

Film Carrier Sockets — PGA Grid Patterns

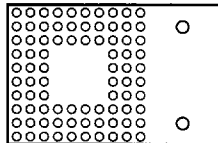
**10 x 10
68 Position
Part No. 382450-1**



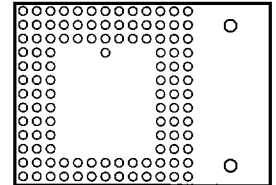
**11 x 11
121 Position
Part No. 382451-3**



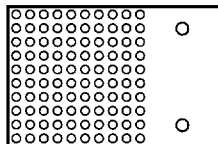
**10 x 10
84 Position
Part No. 382450-2**



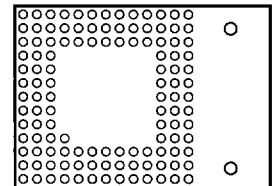
**13 x 13
114 Position
Part No. 382453-1**



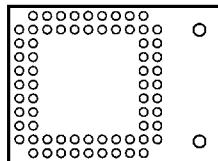
**10 x 10
100 Position
Part No. 382450-3**



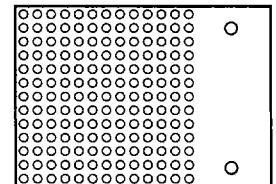
**13 x 13
121 Position
Part No. 382453-2**



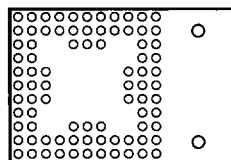
**11 x 11
68 Position
Part No. 382451-1**



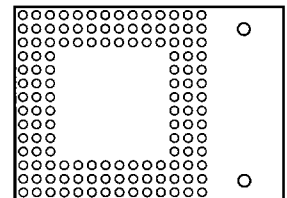
**13 x 13
169 Position
Part No. 382453-3**



**11 x 11
84 Position
Part No. 382451-2**

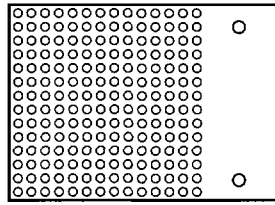


**14 x 14
132 Position
Part No. 382454-1**

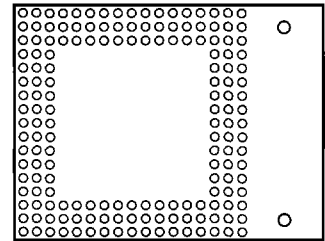


Film Carrier Sockets — PGA Grid Patterns (Continued)

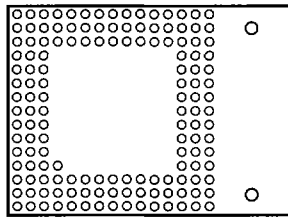
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196 Position
Part No. 382454-2**



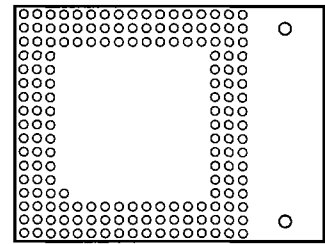
**17 x 17
168 Position
Part No. 382457-1
Part No. 382684-1¹**



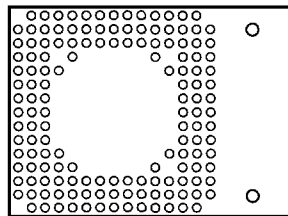
**15 x 15
145 Position
Part No. 382455-1**



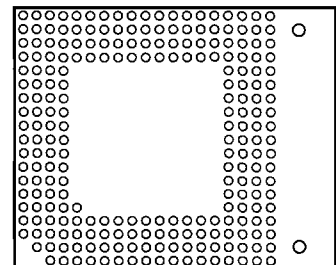
**17 x 17
169 Position
Part No. 382457-2
Part No. 382684-2¹**



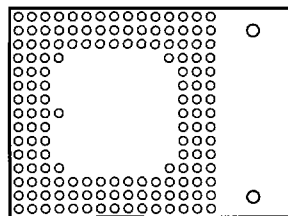
**15 x 15
149 Position
Part No. 382455-2**



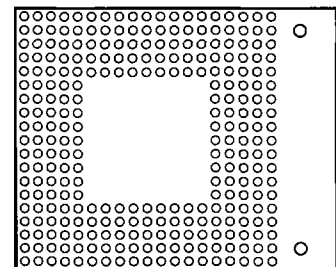
**19 x 19
238 Position
Part No. 382685-1¹**



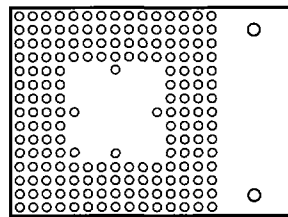
**15 x 15
149 Position
Part No. 382455-3**



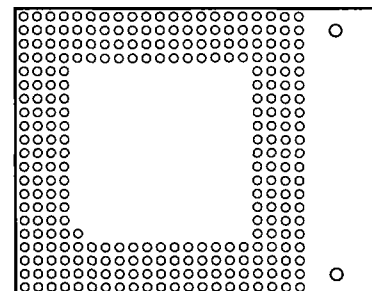
**19 x 19
280 Position
Part No. 382685-2¹**



**15 x 15
181 Position
Part No. 382455-4**

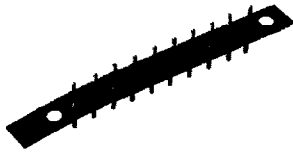


**21 x 21
273 Position
Part No. 382686-1¹**



¹Low force, staggered contacts.

Film Carrier Pins



Materials

Film — Polyimide

Sleeves — Brass, 1/2 Hard
Composition 22, Copper Alloy 360,
QQ-B-626

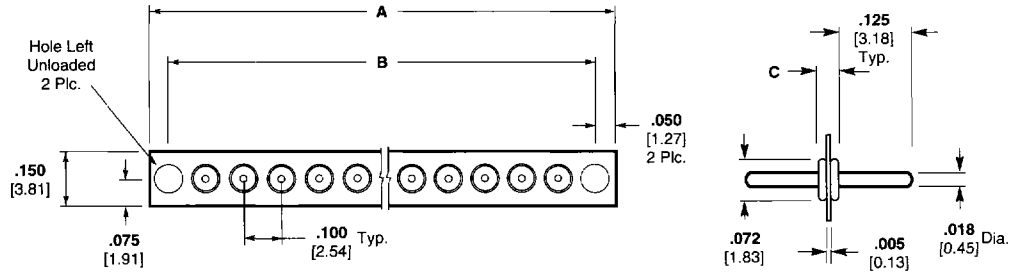
Finish

Terminals —

Gold .000010 [0.00025]
over .000050 [0.00127] Nickel
Tin/Lead .000200 [0.00508]
over .000050 [0.00127] Nickel

Plating Specifications —

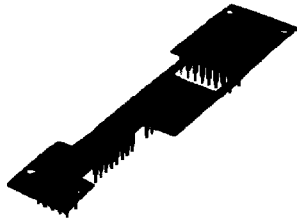
Nickel per QQ-N-290
Gold per MIL-G-45204
Tin/Lead per MIL-P-81728



No. of Pos.	Terminal Type ¹	Dimensions			Part Numbers	
		A	B	C	Terminal	
					Tin	Gold
8	G	1.000 25.40	.900 22.86	.030 0.76	382449-8	382490-8
	H	1.000 25.40	.900 22.86	.070 1.78	382460-8	—
	J	1.000 25.40	.900 22.86	.085 2.16	382461-8	—
10	G	1.200 30.48	1.100 27.94	.030 0.76	1-382449-0	1-382490-0
	H	1.200 30.48	1.100 27.94	.070 1.78	1-382460-0	1-382492-0
	J	1.200 30.48	1.100 27.94	.085 2.16	1-382461-0	1-382494-0
12	G	1.400 35.56	1.300 33.02	.030 0.76	1-382449-2	1-382490-2
14	G	1.600 40.64	1.500 38.10	.030 0.76	1-382449-4	1-382490-4
16	G	1.800 45.72	1.700 43.18	.030 0.76	1-382449-6	1-382490-6
20	G	2.200 55.88	2.100 53.34	.030 0.76	2-382449-0	2-382490-0
24	G	2.600 66.04	2.500 63.05	.030 0.76	2-382449-4	2-382490-4
100	G	10.200 259.08	10.100 256.54	.030 0.76	382449-1	382490-1

¹Standard terminal types are listed on pages 160 and 161.
Any terminal type can be made available in this configuration; contact AMP Incorporated.
Note: See page 159 for samples of terminal types for customer evaluation.

Custom Sheets of Sockets



Maximize Your Socket Loading Rate with Sheets of Sockets

This unique concept in terminal loading, features all the standard advantages of film carrier sockets plus an exceptionally fast pc board loading rate of pins or socket positions.

No expensive tooling or machinery is required. Just send your pc board or copy of artwork to us.

AMP will produce a finished sheet loaded with sockets and ready for your soldering operation.

Cut out areas for loading caps, resistors, IC's or other hardware may be incorporated into the sheet.

Ordering Information

For custom sheets of sockets, send the following information:

- Artwork, pc board or drawing of pc board.
- Locate cutout requirements for high profile pc board components.
- Specify terminal type (Example, A or B, etc. and plating combination gold/tin, gold/gold or tin/tin).

Materials

Film — Polyimide

Terminals — Brass, 1/2 Hard
Composition 22, Copper Alloy 360,
QQ-B-626

Contacts — Beryllium Copper,
1/4 Hard Copper Alloy 172 ASTM-8-
194, QQ-C-533, Heat Treated

Finish

Contacts — .000030 [0.00076]
Gold over .000050 [0.00127]
Nickel or .000150 [0.0038] to
.000275 [0.00699] Tin/Lead Type 1
over .000050 [0.00127] to .000100
[0.00254] Nickel

Sleeves — .000200 [0.00508] to
.000300 [0.00762] Tin/Lead Type 1
over 0.000050 [0.00127] to
.000100 [0.0025] Nickel

Plating Specifications —

Nickel per QQ-N-290
Gold per MIL-G-45204
Tin/Lead per MIL-P-81728

Loading Rate

Loading Rate per Sheet	Pins Per Board/Sheet	Pins Loaded per Hour
20 Seconds Typical ¹	100	18,000
	500	90,000
	1,000	180,000
	2,000	360,000
	3,000	540,000
	4,000	720,000
	5,000	900,000
	10,000	1,800,000

¹Loading rate shown will vary with operator's skill.

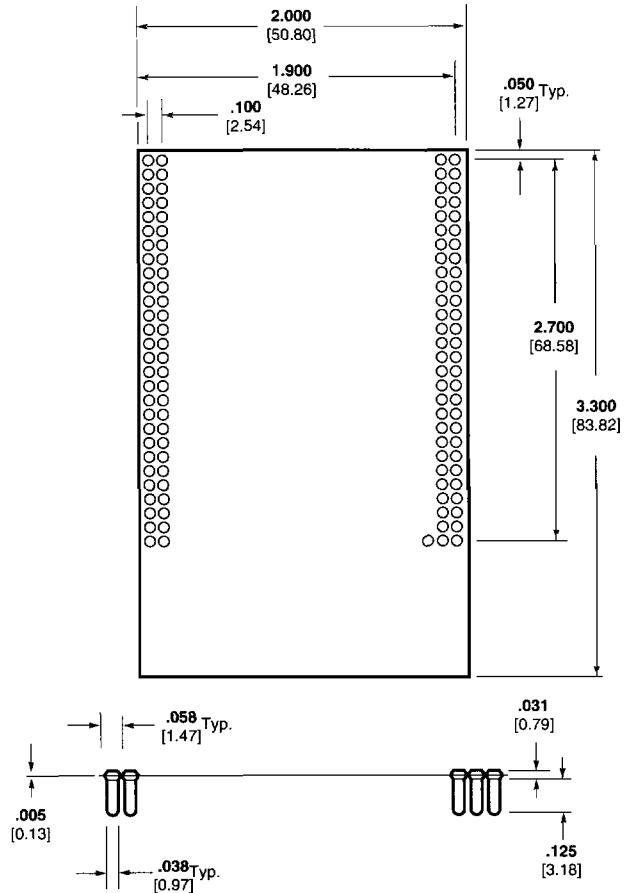
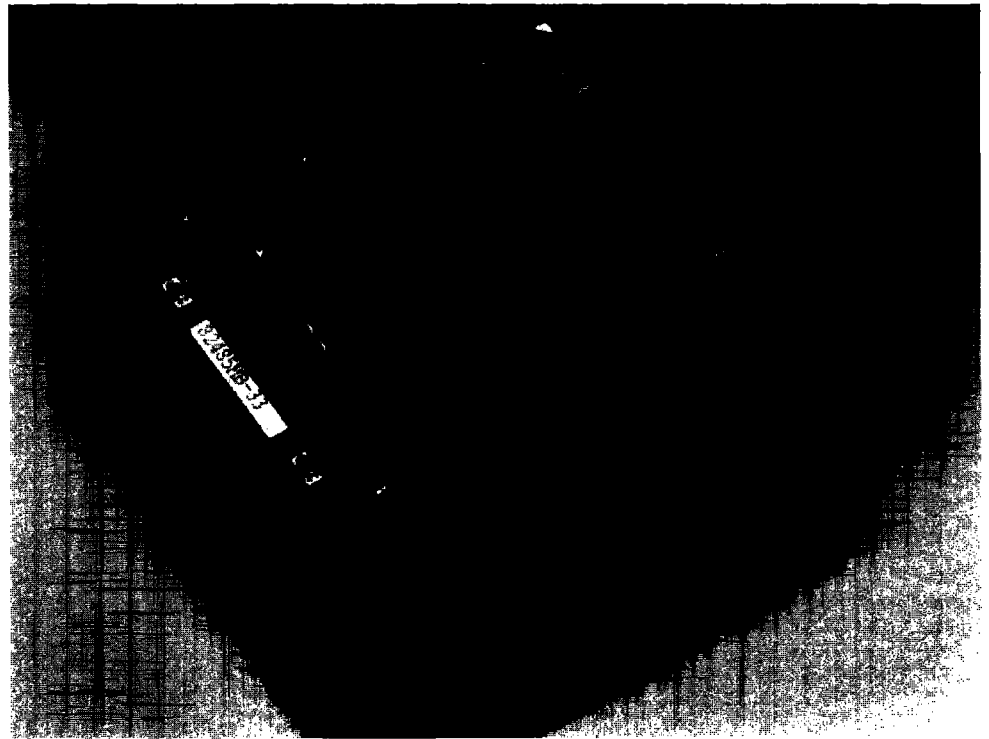
Note: Also available upon request
are custom sheets of sockets
configured as Side-by-Side and
End-to-End DIPS.

Custom Sheets of Sockets (Continued)

**20 × 28 PGA
Film Carrier Socket
for Intel® Turbocache
Controller 82485
Part No. 382518-1**

AMP Film Carrier Sockets, such as the 20 × 28 PGA custom designed socket for Intel's Turbocache Controller 82485 shown here, are ideal for extremely low-profile, high-density applications.

The socket and film carrier withstand temperatures ranging from -259°C to +400°C for compatibility with vapor phase, infrared, hand and wave soldering. The socket/carrier assembly is manually placed on the board. Following soldering, the carrier is peeled away, leaving free-standing socket terminals that allow visual inspection, easy flux removal and excellent heat dissipation. The flexible carrier eliminates concern about contact damage during carrier insertion or extraction.



Film Carrier Socket and Pin Types for Terminal Evaluation

SIP Socket



No. of Pos.	Terminal Type ¹	Part Numbers			
		Contact / Sleeve Tin	Sleeve Tin	Contact / Sleeve Gold	Sleeve Gold
10	A	—		1-382521-0	1-382511-0
	B	1-382445-0		1-382495-0	1-382509-0
	C	1-382499-0		1-382500-0	1-382501-0
	D	1-382496-0		1-382497-0	1-382498-0
	E	1-382505-0		1-382506-0	1-382507-0
	F	1-382502-0		1-382503-0	1-382504-0

¹See page 160 for terminal types.

Materials

Film — Polyimide

Sleeves — Brass, 1/2 Hard
Composition 22, Copper Alloy 360,
QQ-B-626

Contacts — Beryllium Copper,
1/4 Hard Copper Alloy 172 ASTM-8-
194, QQ-C-533, Heat Treated

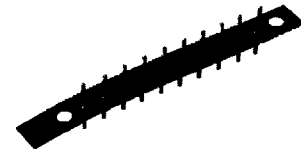
Finish

Contacts — .000030 [0.00076]
Gold over .000050 [0.00127]
Nickel or .000150 [0.0038] to
.000275 [0.00699] Tin/Lead Type
1 over .000050 [0.00127] to
.000100 [0.00254] Nickel

Sleeves — .000010 [0.00025]
Gold over .000050 [0.00127]
Nickel or .000200 [0.00508] to
.000300 [0.00762] Tin/Lead Type
1 over .000050 [0.00127] to
.000100 [0.00254] Nickel

Plating Specifications —
Nickel per QQ-N-290
Gold per MIL-G-45204
Tin/Lead per MIL-P-81728

Pin



No. of Pos.	Terminal Type ¹	Part Numbers	
		Terminals	
		Tin	Gold
10	G	1-382449-0	1-382490-0
	H	1-382460-0	1-382492-0
	J	1-382461-0	1-382494-0

¹See page 161 for terminal types.

Materials

Film — Polyimide

Terminals — Brass, 1/2 Hard
Composition 22, Copper Alloy 360,
QQ-B-626

Finish

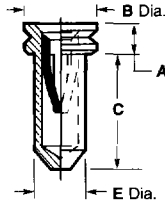
Terminals — .000010 [0.00025]
Gold over .000050 [0.00127]
Nickel or .000200 [0.00508] Tin/
Lead over .000050 [0.00127]
Nickel

Plating Specifications —
Nickel per QQ-N-290
Gold per MIL-G-45204
Tin/Lead per MIL-P-81728

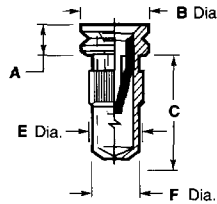
Terminal Types — Sockets

Sockets will accept a .016-.021 [0.41-0.53] diameter or .010 × .018 [0.25 × 0.46] rectangular pin

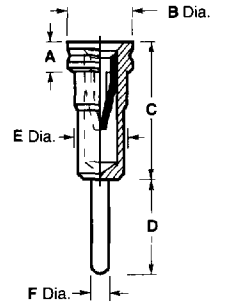
A, B, L and M



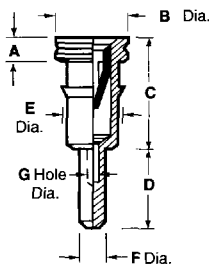
C



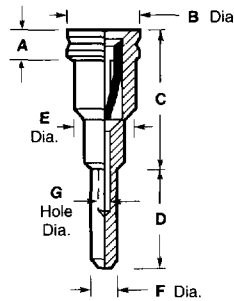
D



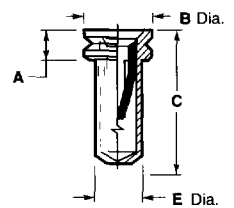
E



F



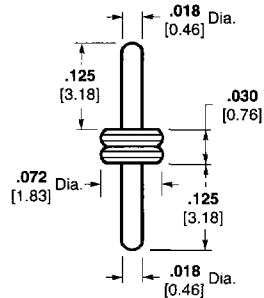
K



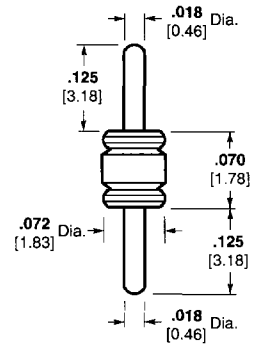
Terminal Type	Minimum Acceptable Pin Length	Dimensions						
		A	B Dia.	C	D Dia.	E Dia.	F Dia.	G Dia.
A	.100 2.54	.031 0.79	.058 1.47	.124 3.15	—	.038 0.97	—	—
B	.110 2.79	.031 0.79	.072 1.83	.125 3.18	—	.053 1.35	—	—
C	.110 2.79	.031 0.79	.072 1.83	.125 3.18	—	.059 1.50	.052 1.32	—
D	.110 2.79	.031 0.79	.072 1.83	.165 4.19	.125 3.18	.056 1.42	.020 0.51	—
E	.090 2.29	.031 0.79	.072 1.83	.095 2.41	.095 2.41	.053 1.50	.028 0.71	.021 0.53
F	.110 2.79	.031 0.79	.072 1.83	.120 3.05	.140 3.56	.059 1.50	.028 0.71	.021 0.53
K	.070 1.78	.031 0.79	.072 1.83	.095 2.41	—	.064 1.63	.053 1.35	—
L	.100 2.54	.031 0.79	.058 1.47	.124 3.15	—	.034 0.86	—	—
M	.100 2.54	.015 0.38	.058 1.47	.140 3.56	—	.034 0.86	—	—

Terminal Types — Pins

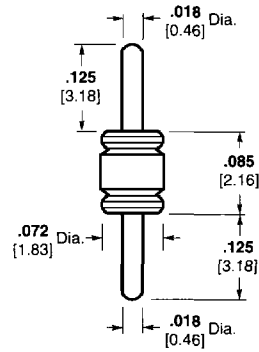
G



H



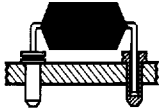
J



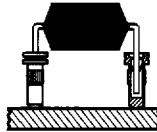
Application Options

For IC Devices

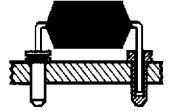
**Type A, B and M
Near Flush Mount
Typical Assembly**



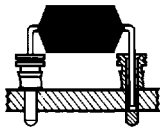
**Type C and K
Surface Mount
Typical Assembly**



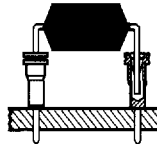
**Type D
Ultra Low Profile
Typical Assembly**



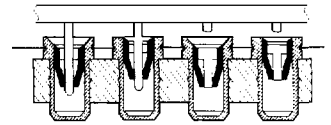
**Type E
Very Low Profile
Solder Tail
Typical Assembly**



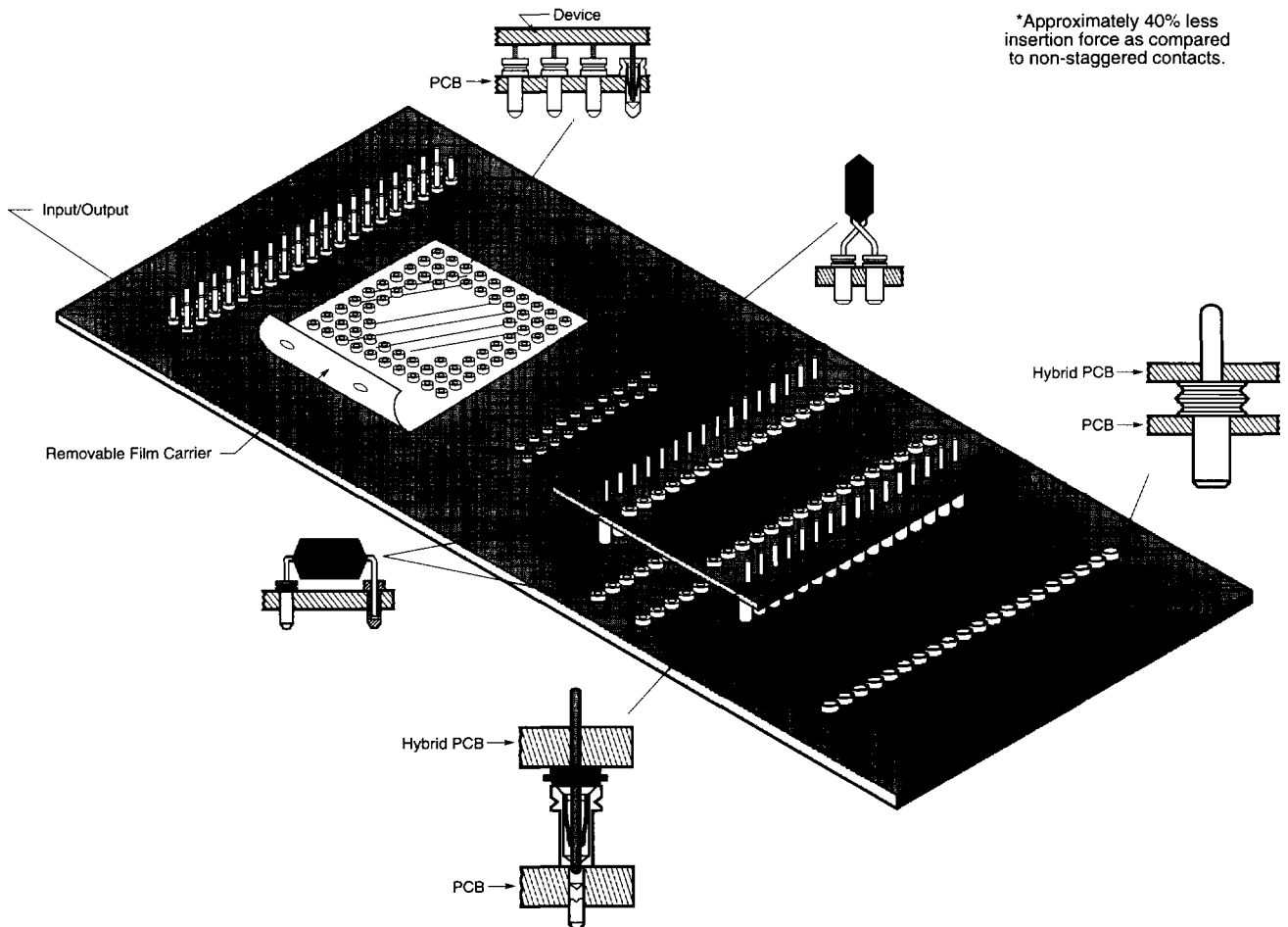
**Type F
Low Profile
Solder Tail Standoff
Typical Assembly**



**Type L
Low Insertion Force*
Staggered Contact Depth**



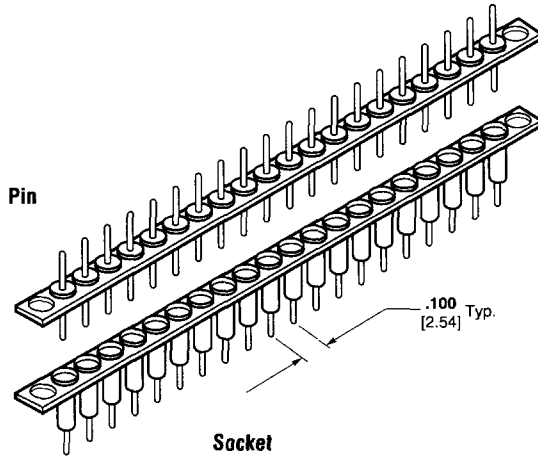
*Approximately 40% less insertion force as compared to non-staggered contacts.



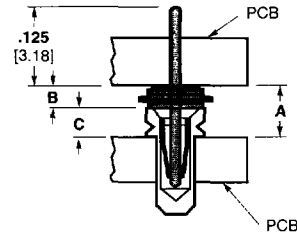
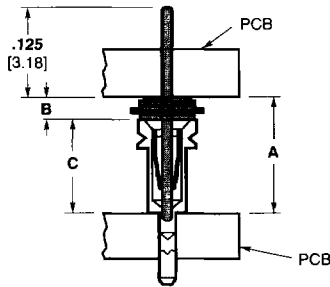
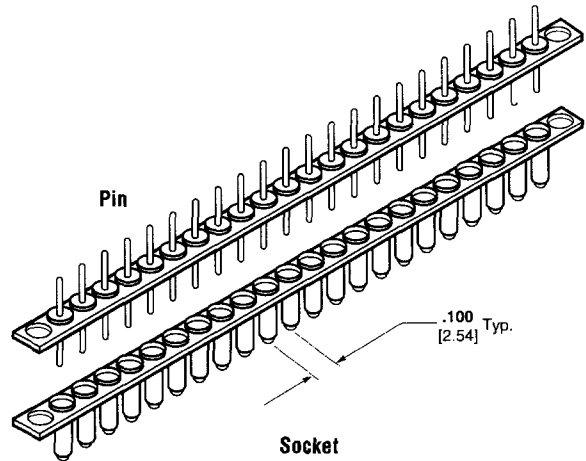
Application Options (Continued)

For Board-to-Board Interconnection

Socket Types D or E



Socket Type A



Pin Assemblies Pin Type ¹	Dimensions			Socket Assemblies Terminal Type ²
	A	B	C	
G	.125 3.18	.030 0.76	.095 2.41	E
H	.165 4.19	.070 1.78	.095 2.41	E
J	.180 4.57	.085 2.16	.095 2.41	E
G	.195 4.95	.030 0.76	.165 4.19	D
H	.235 5.97	.070 1.78	.165 4.19	D
J	.250 6.35	.085 2.16	.165 4.19	D

Pin Assemblies Pin Type ¹	Dimensions			Socket Assemblies Terminal Type ²
	A	B	C	
G	.060 1.52	.030 0.76	.030 0.76	A
H	.100 4.19	.070 1.78	.030 0.76	A
J	.115 2.92	.085 2.16	.030 0.76	A

¹See page 161 for pin types.
²See page 160 for terminal types.

¹See page 161 for pin types.
²See page 160 for terminal types.